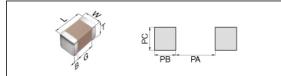


C3216X7R1H224K115AA (TDK item description : C3216X7R1H224KT****)

Applications		Commercial Grade
Feature	General	General (Up to 50V)
Series	C3216 [EIA CC1206]	





Size	
Length(L)	3.20mm +/-0.20mm
Width(W)	1.60mm +/-0.20mm
Thickness(T)	1.15mm +/-0.15mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	1.00mm Min.
Recommended Land Pattern(PA)	2.10 to 2.50mm (Flow Soldering) 2.00 to 2.40mm (Reflow Solde
Recommended Land Pattern(PB)	1.10 to 1.30mm (Flow Soldering) 1.00 to 1.20mm (Reflow Solde
Recommended Land Pattern(PC)	1.00 to 1.30mm (Flow Soldering) 1.10 to 1.60mm (Reflow Solde
Recommended Slit Pattern(SD)	

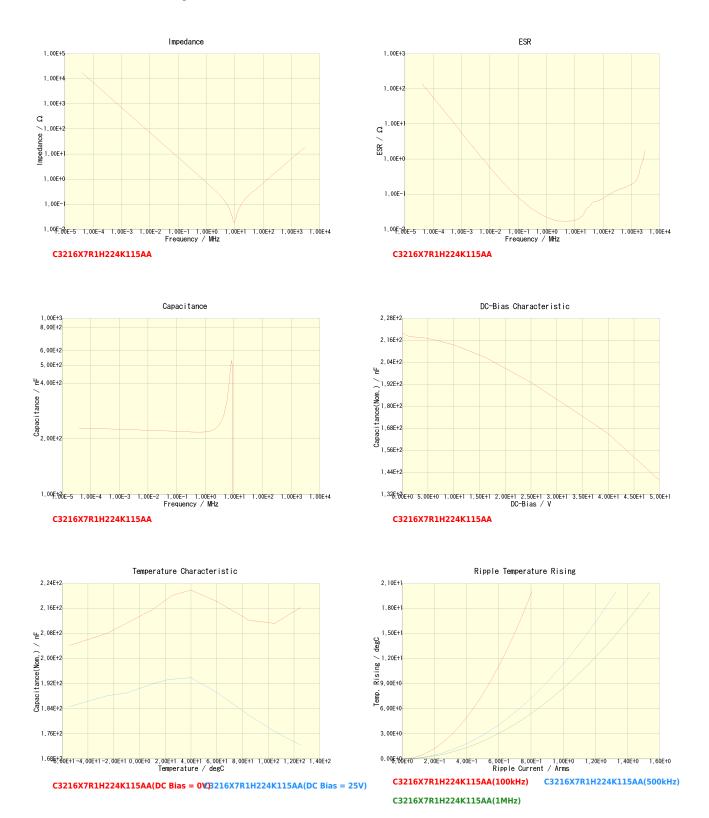
Electrical Characteristics				
Capacitance	220nF +/-10%			
Rated Voltage	50Vdc			
Temperature Characteristic	X7R(+/-15%)			
Dissipation Factor	3% Max.			
Insulation Resistance	2272MΩ Min.			

Other			
Soldering Method	Reflow, Flow		
AEC Q200	No		
Packing	Blister (Plastic)Taping [180mm Reel]		
Package Quantity	2000Pcs Min.		

This PDF document was created based on the data listed on the TDK Corporation website.All specifications are subject to change without notice.

C3216X7R1H224K115AA

Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



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